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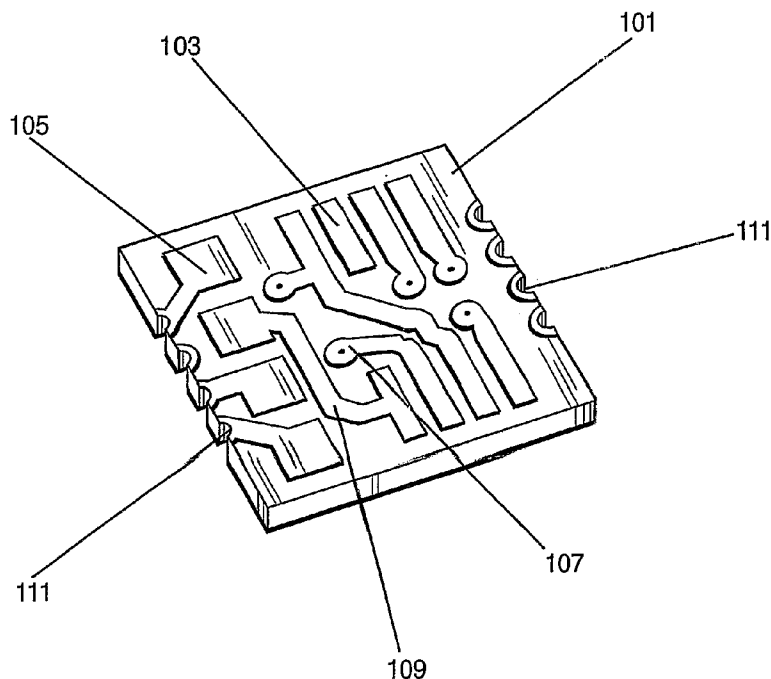
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(54) Title: MICRO-CASTELLATED INTERPOSER



(57) Abstract: A miniature PWB (101) with features that incorporate the required circuitry changes and component footprints (105), which has been enhanced with micro-castellations (111) such as those found on ceramic surface mount packages. The miniature PWB (101) is mounted on the circuit board (125) using techniques well known in the art. This combination of technologies provides an adaptable, durable interconnect methodology, which allows for circuit (109) and part changes (113, 115, 117) without changing the layout of the base printed wiring board (125).

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